



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	2880
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	113
Number of Gates	48000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	-55°C ~ 125°C (TC)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a54sx32a-1tq144m">https://www.e-xfl.com/product-detail/microchip-technology/a54sx32a-1tq144m</a>

# General Description

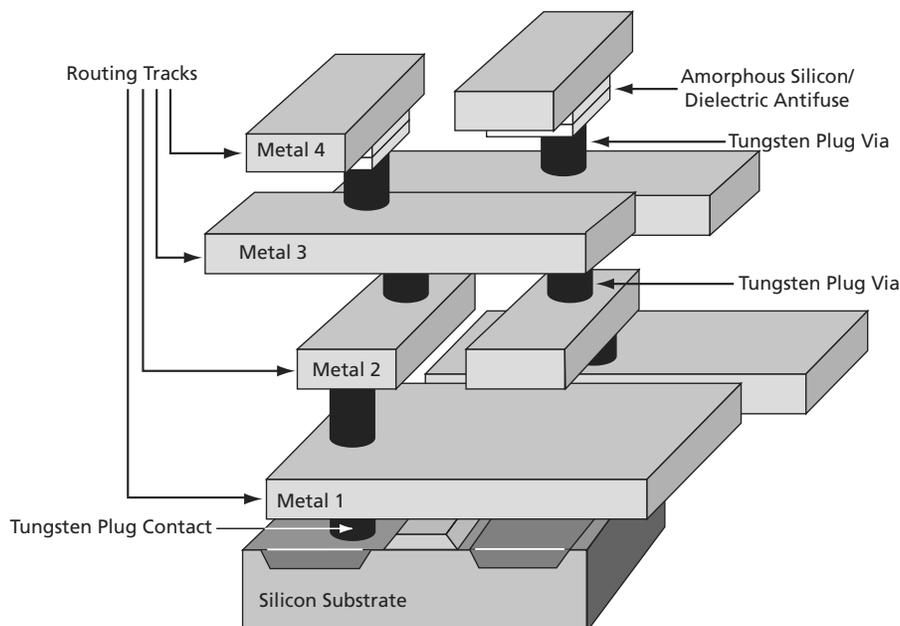
## Introduction

The Actel SX-A family of FPGAs offers a cost-effective, single-chip solution for low-power, high-performance designs. Fabricated on 0.22  $\mu\text{m}$  / 0.25  $\mu\text{m}$  CMOS antifuse technology and with the support of 2.5 V, 3.3 V and 5 V I/Os, the SX-A is a versatile platform to integrate designs while significantly reducing time-to-market.

## SX-A Family Architecture

The SX-A family's device architecture provides a unique approach to module organization and chip routing that satisfies performance requirements and delivers the most optimal register/logic mix for a wide variety of applications.

Interconnection between these logic modules is achieved using Actel's patented metal-to-metal programmable antifuse interconnect elements (Figure 1-1). The antifuses are normally open circuit and, when programmed, form a permanent low-impedance connection.



**Note:** The A54SX72A device has four layers of metal with the antifuse between Metal 3 and Metal 4. The A54SX08A, A54SX16A, and A54SX32A devices have three layers of metal with the antifuse between Metal 2 and Metal 3.

Figure 1-1 • SX-A Family Interconnect Elements

## Logic Module Design

The SX-A family architecture is described as a “sea-of-modules” architecture because the entire floor of the device is covered with a grid of logic modules with virtually no chip area lost to interconnect elements or routing. The Actel SX-A family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell).

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable, using the S0 and S1 lines control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility while allowing mapping of synthesized functions into the SX-A FPGA. The clock source for the R-cell can be chosen from either the hardwired clock, the routed clocks, or internal logic.

The C-cell implements a range of combinatorial functions of up to five inputs (Figure 1-3). Inclusion of the DB input and its associated inverter function allows up to 4,000

different combinatorial functions to be implemented in a single module. An example of the flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 1.9 ns propagation delays.

## Module Organization

All C-cell and R-cell logic modules are arranged into horizontal banks called Clusters. There are two types of Clusters: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells.

Clusters are grouped together into SuperClusters (Figure 1-4 on page 1-3). SuperCluster 1 is a two-wide grouping of Type 1 Clusters. SuperCluster 2 is a two-wide group containing one Type 1 Cluster and one Type 2 Cluster. SX-A devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flip-flops.

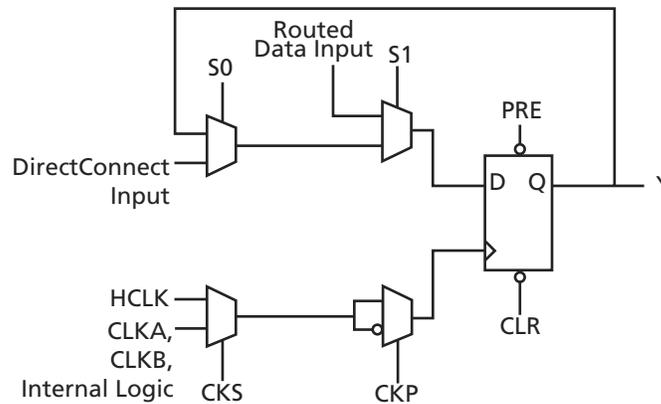


Figure 1-2 • R-Cell

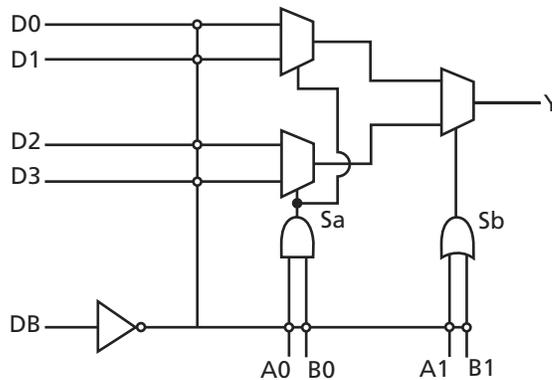


Figure 1-3 • C-Cell

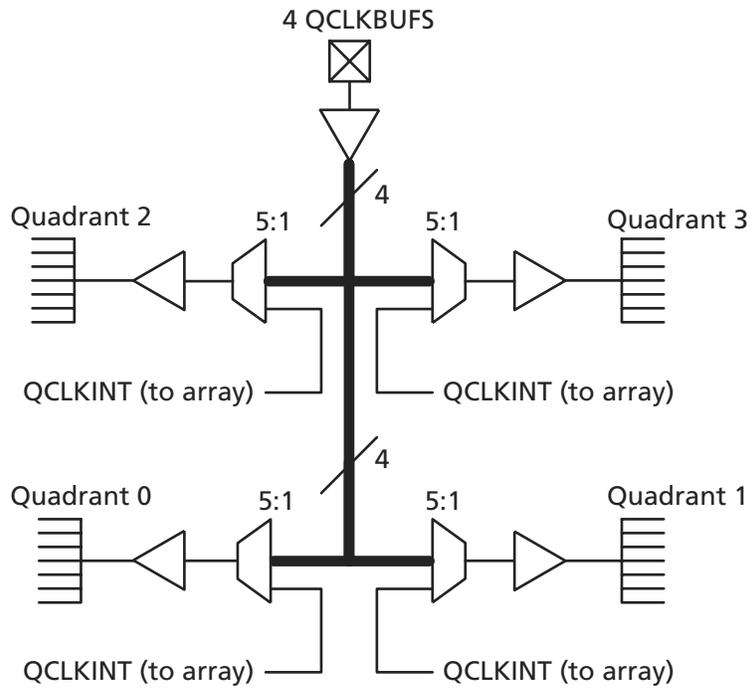


Figure 1-9 • SX-A QCLK Architecture

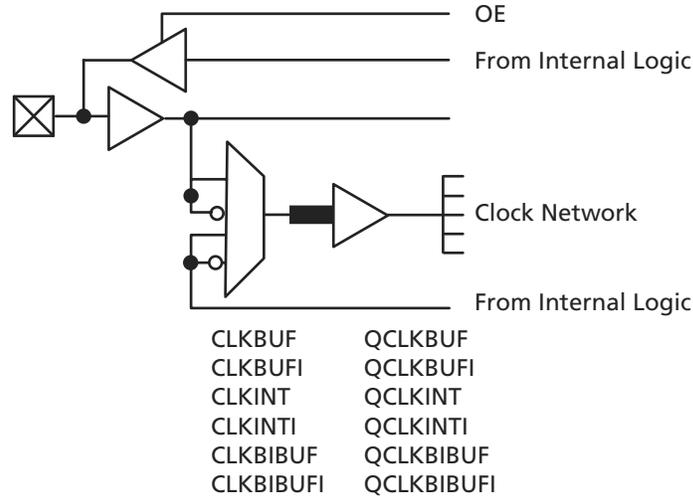


Figure 1-10 • A54SX72A Routed Clock and QCLK Buffer



Figure 2-2 shows the 3.3 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

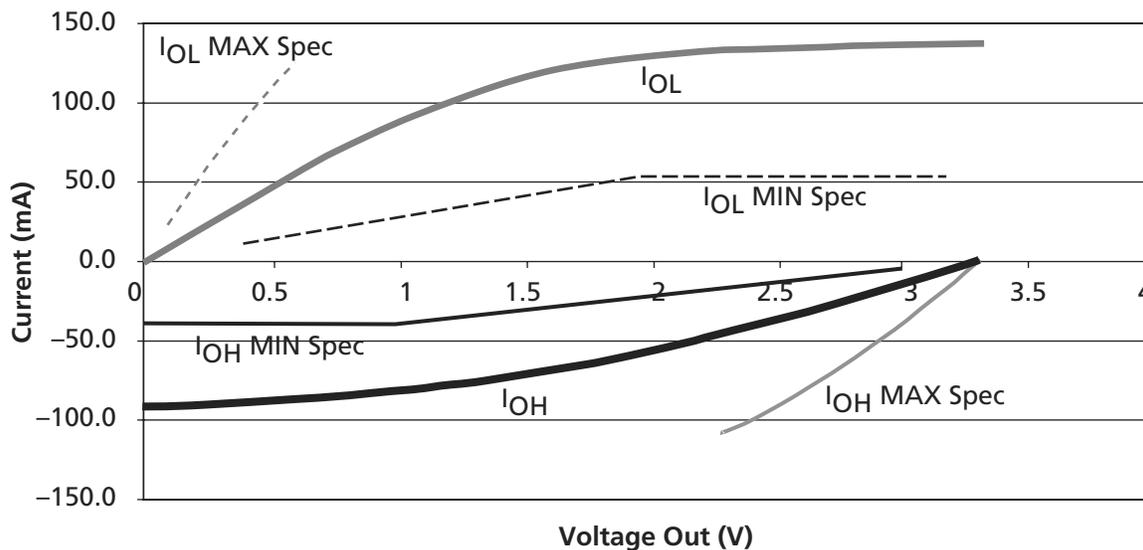


Figure 2-2 • 3.3 V PCI V/I Curve for SX-A Family

$$I_{OH} = (98.0/V_{CC1}) * (V_{OUT} - V_{CC1}) * (V_{OUT} + 0.4V_{CC1})$$

for  $0.7 V_{CC1} < V_{OUT} < V_{CC1}$

EQ 2-3

$$I_{OL} = (256/V_{CC1}) * V_{OUT} * (V_{CC1} - V_{OUT})$$

for  $0V < V_{OUT} < 0.18 V_{CC1}$

EQ 2-4

**Where:**

- $C_{EQCM}$  = Equivalent capacitance of combinatorial modules (C-cells) in pF
- $C_{EQSM}$  = Equivalent capacitance of sequential modules (R-Cells) in pF
- $C_{EQI}$  = Equivalent capacitance of input buffers in pF
- $C_{EQO}$  = Equivalent capacitance of output buffers in pF
- $C_{EQCR}$  = Equivalent capacitance of CLKA/B in pF
- $C_{EQHV}$  = Variable capacitance of HCLK in pF
- $C_{EQHF}$  = Fixed capacitance of HCLK in pF
- $C_L$  = Output lead capacitance in pF
- $f_m$  = Average logic module switching rate in MHz
- $f_n$  = Average input buffer switching rate in MHz
- $f_p$  = Average output buffer switching rate in MHz
- $f_{q1}$  = Average CLKA rate in MHz
- $f_{q2}$  = Average CLKB rate in MHz
- $f_{s1}$  = Average HCLK rate in MHz
- $m$  = Number of logic modules switching at  $f_m$
- $n$  = Number of input buffers switching at  $f_n$
- $p$  = Number of output buffers switching at  $f_p$
- $q_1$  = Number of clock loads on CLKA
- $q_2$  = Number of clock loads on CLKB
- $r_1$  = Fixed capacitance due to CLKA
- $r_2$  = Fixed capacitance due to CLKB
- $s_1$  = Number of clock loads on HCLK
- $x$  = Number of I/Os at logic low
- $y$  = Number of I/Os at logic high

**Table 2-11 • CEQ Values for SX-A Devices**

	<b>A54SX08A</b>	<b>A54SX16A</b>	<b>A54SX32A</b>	<b>A54SX72A</b>
Combinatorial modules ( $C_{EQCM}$ )	1.70 pF	2.00 pF	2.00 pF	1.80 pF
Sequential modules ( $C_{EQSM}$ )	1.50 pF	1.50 pF	1.30 pF	1.50 pF
Input buffers ( $C_{EQI}$ )	1.30 pF	1.30 pF	1.30 pF	1.30 pF
Output buffers ( $C_{EQO}$ )	7.40 pF	7.40 pF	7.40 pF	7.40 pF
Routed array clocks ( $C_{EQCR}$ )	1.05 pF	1.05 pF	1.05 pF	1.05 pF
Dedicated array clocks – variable ( $C_{EQHV}$ )	0.85 pF	0.85 pF	0.85 pF	0.85 pF
Dedicated array clocks – fixed ( $C_{EQHF}$ )	30.00 pF	55.00 pF	110.00 pF	240.00 pF
Routed array clock A ( $r_1$ )	35.00 pF	50.00 pF	90.00 pF	310.00 pF

To determine the heat sink's thermal performance, use the following equation:

$$\theta_{JA(TOTAL)} = \theta_{JC} + \theta_{CS} + \theta_{SA}$$

EQ 2-14

where:

$$\theta_{CS} = 0.37^{\circ}C/W$$

= thermal resistance of the interface material between the case and the heat sink, usually provided by the thermal interface manufacturer

$$\theta_{SA} = \text{thermal resistance of the heat sink in } ^{\circ}C/W$$

$$\theta_{SA} = \theta_{JA(TOTAL)} - \theta_{JC} - \theta_{CS}$$

EQ 2-15

$$\theta_{SA} = 13.33^{\circ}C/W - 3.20^{\circ}C/W - 0.37^{\circ}C/W$$

$$\theta_{SA} = 9.76^{\circ}C/W$$

A heat sink with a thermal resistance of  $9.76^{\circ}C/W$  or better should be used. Thermal resistance of heat sinks is a function of airflow. The heat sink performance can be significantly improved with the presence of airflow.

Carefully estimating thermal resistance is important in the long-term reliability of an Actel FPGA. Design engineers should always correlate the power consumption of the device with the maximum allowable power dissipation of the package selected for that device, using the provided thermal resistance data.

Note: The values may vary depending on the application.

## Output Buffer Delays

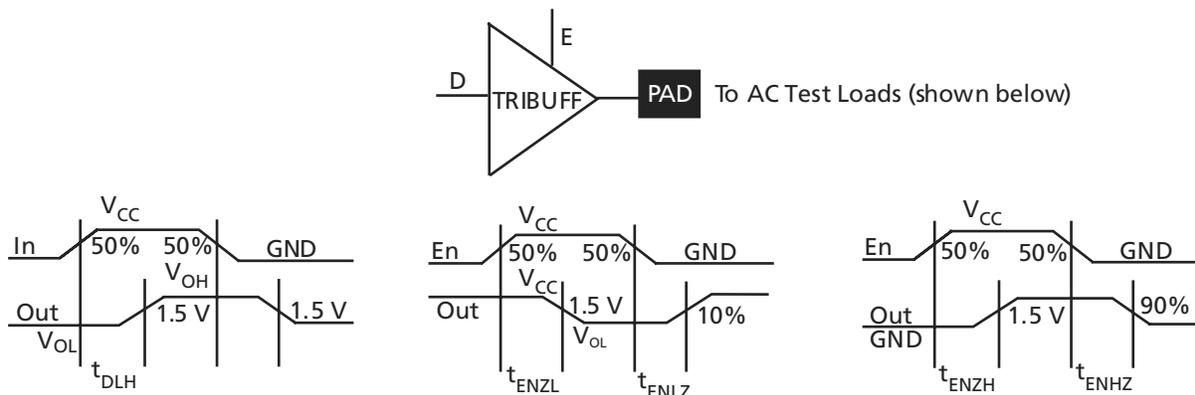


Figure 2-4 • Output Buffer Delays

## AC Test Loads

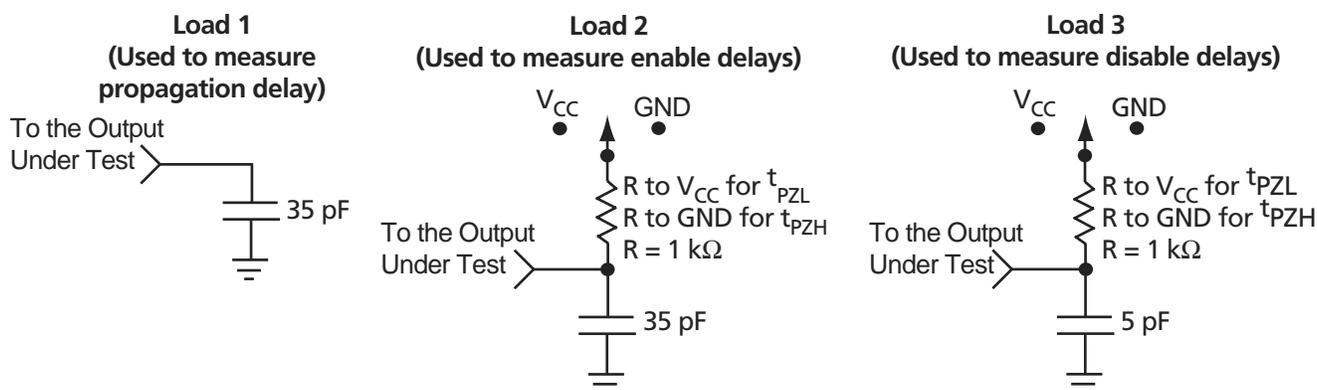


Figure 2-5 • AC Test Loads

Table 2-18 • A54SX08A Timing Characteristics  
(Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

Parameter	Description	-2 Speed		-1 Speed		Std. Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>2.5 V LVCMOS Output Module Timing<sup>1,2</sup></b>										
$t_{DLH}$	Data-to-Pad Low to High		3.9		4.4		5.2		7.2	ns
$t_{DHL}$	Data-to-Pad High to Low		3.0		3.4		3.9		5.5	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew		13.3		15.1		17.7		24.8	ns
$t_{ENZL}$	Enable-to-Pad, Z to L		2.8		3.2		3.7		5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew		13.7		15.5		18.2		25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H		3.9		4.4		5.2		7.2	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z		2.5		2.8		3.3		4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z		3.0		3.4		3.9		5.5	ns
$d_{TLH}^3$	Delta Low to High		0.037		0.043		0.051		0.071	ns/pF
$d_{THL}^3$	Delta High to Low		0.017		0.023		0.023		0.037	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew		0.06		0.071		0.086		0.117	ns/pF

**Note:**

- Delays based on 35 pF loading.
- The equivalent I/O Attribute Editor settings for 2.5 V LVCMOS is 2.5 V LVTTTL in the software.
- To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF

$d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

**SX-A Family FPGAs**

Table 2-22 • **A54SX16A Timing Characteristics**  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

Parameter	Description	-3 Speed*		-2 Speed		-1 Speed		Std. Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Dedicated (Hardwired) Array Clock Networks</b>												
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.2		1.4		1.6		1.8		2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.0		1.1		1.2		1.5		2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4		1.7		1.9		2.2		3.0		ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4		1.7		1.9		2.2		3.0		ns
$t_{HCKSW}$	Maximum Skew		0.3		0.3		0.4		0.4		0.7	ns
$t_{HP}$	Minimum Period	2.8		3.4		3.8		4.4		6.0		ns
$f_{HMAX}$	Maximum Frequency		357		294		263		227		167	MHz
<b>Routed Array Clock Networks</b>												
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		1.0		1.2		1.3		1.6		2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.1		1.3		1.5		1.7		2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		1.1		1.3		1.5		1.7		2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.1		1.3		1.5		1.7		2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		1.3		1.5		1.7		2.0		2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		1.3		1.5		1.7		2.0		2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4		1.7		1.9		2.2		3.0		ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4		1.7		1.9		2.2		3.0		ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.8		0.9		1.0		1.2		1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)		0.8		0.9		1.0		1.2		1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)		1.0		1.1		1.3		1.5		2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-29 • **A54SX32A Timing Characteristics**  
**(Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )**

Parameter	Description	-3 Speed*		-2 Speed		-1 Speed		Std. Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Dedicated (Hardwired) Array Clock Networks</b>												
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.7		2.0		2.2		2.6		4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.7		2.0		2.2		2.6		4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4		1.6		1.8		2.1		2.9		ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4		1.6		1.8		2.1		2.9		ns
$t_{HCKSW}$	Maximum Skew		0.6		0.6		0.7		0.8		1.3	ns
$t_{HP}$	Minimum Period	2.8		3.2		3.6		4.2		5.8		ns
$f_{HMAX}$	Maximum Frequency		357		313		278		238		172	MHz
<b>Routed Array Clock Networks</b>												
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		2.2		2.5		2.9		3.4		4.7	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		2.1		2.4		2.7		3.2		4.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		2.4		2.7		3.1		3.6		5.1	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		2.2		2.5		2.8		3.3		4.6	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		2.5		2.9		3.2		3.8		5.3	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		2.4		2.7		3.1		3.6		5.0	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4		1.6		1.8		2.1		2.9		ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4		1.6		1.8		2.1		2.9		ns
$t_{RCKSW}$	Maximum Skew (Light Load)		1.0		1.1		1.3		1.5		2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)		0.9		1.0		1.2		1.4		1.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)		0.9		1.0		1.2		1.4		1.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-33 • A54SX32A Timing Characteristics  
(Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

Parameter	Description	-3 Speed <sup>1</sup>		-2 Speed		-1 Speed		Std. Speed	-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	
<b>3.3 V PCI Output Module Timing<sup>2</sup></b>											
$t_{DLH}$	Data-to-Pad Low to High	1.9	2.2	2.4	2.9	4.0	ns				
$t_{DHL}$	Data-to-Pad High to Low	2.0	2.3	2.6	3.1	4.3	ns				
$t_{ENZL}$	Enable-to-Pad, Z to L	1.4	1.7	1.9	2.2	3.1	ns				
$t_{ENZH}$	Enable-to-Pad, Z to H	1.9	2.2	2.4	2.9	4.0	ns				
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.2	3.8	5.3	ns				
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.0	2.3	2.6	3.1	4.3	ns				
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF				
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF				
<b>3.3 V LVTTL Output Module Timing<sup>4</sup></b>											
$t_{DLH}$	Data-to-Pad Low to High	2.6	3.0	3.4	4.0	5.6	ns				
$t_{DHL}$	Data-to-Pad High to Low	2.6	3.0	3.3	3.9	5.5	ns				
$t_{DHLs}$	Data-to-Pad High to Low—low slew	9.0	10.4	11.8	13.8	19.3	ns				
$t_{ENZL}$	Enable-to-Pad, Z to L	2.2	2.6	2.9	3.4	4.8	ns				
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	15.8	18.9	21.3	25.4	34.9	ns				
$t_{ENZH}$	Enable-to-Pad, Z to H	2.6	3.0	3.4	4.0	5.6	ns				
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.9	3.3	3.7	4.4	6.2	ns				
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.6	3.0	3.3	3.9	5.5	ns				
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF				
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF				
$d_{THLS}^3$	Delta High to Low—low slew	0.053	0.053	0.067	0.073	0.107	ns/pF				

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 10 pF loading and 25 Ω resistance.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

Table 2-36 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

Parameter	Description	-3 Speed*		-2 Speed		-1 Speed		Std. Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		3.0		3.4		3.9		4.6		6.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		2.9		3.4		3.8		4.5		6.3	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2		ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2		ns
$t_{QCKSW}$	Maximum Skew (Light Load)		0.2		0.3		0.3		0.3		0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)		0.4		0.5		0.5		0.6		0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)		0.4		0.5		0.5		0.6		0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

## SX-A Family FPGAs

Table 2-38 • A54SX72A Timing Characteristics  
(Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

Parameter	Description	-3 Speed*		-2 Speed		-1 Speed		Std. Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Dedicated (Hardwired) Array Clock Networks</b>												
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.6		1.8		2.1		2.4		3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.6		1.9		2.1		2.5		3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2		ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2		ns
$t_{HCKSW}$	Maximum Skew		1.4		1.6		1.8		2.1		3.3	ns
$t_{HP}$	Minimum Period	3.0		3.4		4.0		4.6		6.4		ns
$f_{HMAX}$	Maximum Frequency		333		294		250		217		156	MHz
<b>Routed Array Clock Networks</b>												
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		2.3		2.6		3.0		3.5		4.9	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		2.8		3.2		3.6		4.3		6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		2.5		2.9		3.2		3.8		5.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		3.0		3.4		3.9		4.6		6.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		2.6		3.0		3.4		3.9		5.5	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		3.2		3.6		4.1		4.8		6.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2		ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2		ns
$t_{RCKSW}$	Maximum Skew (Light Load)		1.9		2.2		2.5		3.0		4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)		1.9		2.2		2.5		3.0		4.1	ns
$t_{RCKSW}$	Maximum Skew (100% Load)		1.9		2.2		2.5		3.0		4.1	ns
<b>Quadrant Array Clock Networks</b>												
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		1.2		1.4		1.6		1.8		2.6	ns
$t_{QCHL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.3		1.4		1.6		1.9		2.7	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		1.4		1.6		1.8		2.1		3.0	ns
$t_{QCHL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.4		1.7		1.9		2.2		3.1	ns

**Note:** \*All -3 speed grades have been discontinued.

208-Pin PQFP				
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function	A54SX72A Function
71	I/O	I/O	I/O	I/O
72	I/O	I/O	I/O	I/O
73	NC	I/O	I/O	I/O
74	I/O	I/O	I/O	QCLKA
75	NC	I/O	I/O	I/O
76	PRB, I/O	PRB, I/O	PRB, I/O	PRB, I/O
77	GND	GND	GND	GND
78	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
79	GND	GND	GND	GND
80	NC	NC	NC	NC
81	I/O	I/O	I/O	I/O
82	HCLK	HCLK	HCLK	HCLK
83	I/O	I/O	I/O	V <sub>CCI</sub>
84	I/O	I/O	I/O	QCLKB
85	NC	I/O	I/O	I/O
86	I/O	I/O	I/O	I/O
87	I/O	I/O	I/O	I/O
88	NC	I/O	I/O	I/O
89	I/O	I/O	I/O	I/O
90	I/O	I/O	I/O	I/O
91	NC	I/O	I/O	I/O
92	I/O	I/O	I/O	I/O
93	I/O	I/O	I/O	I/O
94	NC	I/O	I/O	I/O
95	I/O	I/O	I/O	I/O
96	I/O	I/O	I/O	I/O
97	NC	I/O	I/O	I/O
98	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
99	I/O	I/O	I/O	I/O
100	I/O	I/O	I/O	I/O
101	I/O	I/O	I/O	I/O
102	I/O	I/O	I/O	I/O
103	TDO, I/O	TDO, I/O	TDO, I/O	TDO, I/O
104	I/O	I/O	I/O	I/O
105	GND	GND	GND	GND

208-Pin PQFP				
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function	A54SX72A Function
106	NC	I/O	I/O	I/O
107	I/O	I/O	I/O	I/O
108	NC	I/O	I/O	I/O
109	I/O	I/O	I/O	I/O
110	I/O	I/O	I/O	I/O
111	I/O	I/O	I/O	I/O
112	I/O	I/O	I/O	I/O
113	I/O	I/O	I/O	I/O
114	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	NC	I/O	I/O	GND
117	I/O	I/O	I/O	V <sub>CCA</sub>
118	I/O	I/O	I/O	I/O
119	NC	I/O	I/O	I/O
120	I/O	I/O	I/O	I/O
121	I/O	I/O	I/O	I/O
122	NC	I/O	I/O	I/O
123	I/O	I/O	I/O	I/O
124	I/O	I/O	I/O	I/O
125	NC	I/O	I/O	I/O
126	I/O	I/O	I/O	I/O
127	I/O	I/O	I/O	I/O
128	I/O	I/O	I/O	I/O
129	GND	GND	GND	GND
130	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
131	GND	GND	GND	GND
132	NC	NC	NC	I/O
133	I/O	I/O	I/O	I/O
134	I/O	I/O	I/O	I/O
135	NC	I/O	I/O	I/O
136	I/O	I/O	I/O	I/O
137	I/O	I/O	I/O	I/O
138	NC	I/O	I/O	I/O
139	I/O	I/O	I/O	I/O
140	I/O	I/O	I/O	I/O

100-TQFP			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
1	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O
4	I/O	I/O	I/O
5	I/O	I/O	I/O
6	I/O	I/O	I/O
7	TMS	TMS	TMS
8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
9	GND	GND	GND
10	I/O	I/O	I/O
11	I/O	I/O	I/O
12	I/O	I/O	I/O
13	I/O	I/O	I/O
14	I/O	I/O	I/O
15	I/O	I/O	I/O
16	TRST, I/O	TRST, I/O	TRST, I/O
17	I/O	I/O	I/O
18	I/O	I/O	I/O
19	I/O	I/O	I/O
20	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
21	I/O	I/O	I/O
22	I/O	I/O	I/O
23	I/O	I/O	I/O
24	I/O	I/O	I/O
25	I/O	I/O	I/O
26	I/O	I/O	I/O
27	I/O	I/O	I/O
28	I/O	I/O	I/O
29	I/O	I/O	I/O
30	I/O	I/O	I/O
31	I/O	I/O	I/O
32	I/O	I/O	I/O
33	I/O	I/O	I/O
34	PRB, I/O	PRB, I/O	PRB, I/O
35	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>

100-TQFP			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
36	GND	GND	GND
37	NC	NC	NC
38	I/O	I/O	I/O
39	HCLK	HCLK	HCLK
40	I/O	I/O	I/O
41	I/O	I/O	I/O
42	I/O	I/O	I/O
43	I/O	I/O	I/O
44	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
45	I/O	I/O	I/O
46	I/O	I/O	I/O
47	I/O	I/O	I/O
48	I/O	I/O	I/O
49	TDO, I/O	TDO, I/O	TDO, I/O
50	I/O	I/O	I/O
51	GND	GND	GND
52	I/O	I/O	I/O
53	I/O	I/O	I/O
54	I/O	I/O	I/O
55	I/O	I/O	I/O
56	I/O	I/O	I/O
57	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
58	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
59	I/O	I/O	I/O
60	I/O	I/O	I/O
61	I/O	I/O	I/O
62	I/O	I/O	I/O
63	I/O	I/O	I/O
64	I/O	I/O	I/O
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
68	GND	GND	GND
69	GND	GND	GND
70	I/O	I/O	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
D11	V <sub>CCA</sub>
D12	NC
D13	I/O
D14	I/O
D15	I/O
D16	I/O
D17	I/O
D18	I/O
D19	I/O
D20	I/O
D21	I/O
D22	I/O
D23	I/O
E1	V <sub>CCI</sub>
E2	I/O
E3	I/O
E4	I/O
E20	I/O
E21	I/O
E22	I/O
E23	I/O
F1	I/O
F2	TMS
F3	I/O
F4	I/O
F20	I/O
F21	I/O
F22	I/O
F23	I/O
G1	I/O
G2	I/O
G3	I/O
G4	I/O
G20	I/O
G21	I/O
G22	I/O
G23	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
H1	I/O
H2	I/O
H3	I/O
H4	I/O
H20	V <sub>CCA</sub>
H21	I/O
H22	I/O
H23	I/O
J1	NC
J2	I/O
J3	I/O
J4	I/O
J20	I/O
J21	I/O
J22	I/O
J23	I/O
K1	I/O
K2	I/O
K3	I/O
K4	I/O
K10	GND
K11	GND
K12	GND
K13	GND
K14	GND
K20	I/O
K21	I/O
K22	I/O
K23	I/O
L1	I/O
L2	I/O
L3	I/O
L4	NC
L10	GND
L11	GND
L12	GND
L13	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
L14	GND
L20	NC
L21	I/O
L22	I/O
L23	NC
M1	I/O
M2	I/O
M3	I/O
M4	V <sub>CCA</sub>
M10	GND
M11	GND
M12	GND
M13	GND
M14	GND
M20	V <sub>CCA</sub>
M21	I/O
M22	I/O
M23	V <sub>CCI</sub>
N1	I/O
N2	TRST, I/O
N3	I/O
N4	I/O
N10	GND
N11	GND
N12	GND
N13	GND
N14	GND
N20	NC
N21	I/O
N22	I/O
N23	I/O
P1	I/O
P2	I/O
P3	I/O
P4	I/O
P10	GND
P11	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
P12	GND
P13	GND
P14	GND
P20	I/O
P21	I/O
P22	I/O
P23	I/O
R1	I/O
R2	I/O
R3	I/O
R4	I/O
R20	I/O
R21	I/O
R22	I/O
R23	I/O
T1	I/O
T2	I/O
T3	I/O
T4	I/O
T20	I/O
T21	I/O
T22	I/O
T23	I/O
U1	I/O
U2	I/O
U3	V <sub>CCA</sub>
U4	I/O
U20	I/O
U21	V <sub>CCA</sub>
U22	I/O
U23	I/O
V1	V <sub>CCI</sub>
V2	I/O
V3	I/O
V4	I/O
V20	I/O
V21	I/O

## 256-Pin FBGA

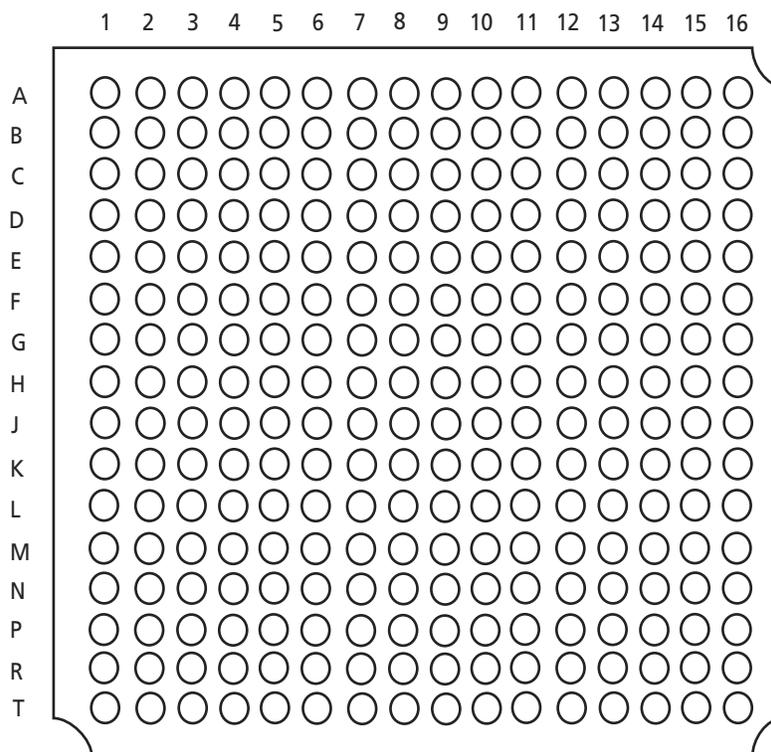


Figure 3-7 • 256-Pin FBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.actel.com/products/rescenter/package/index.html>.

484-Pin FBGA		
Pin Number	A54SX32A Function	A54SX72A Function
C19	I/O	I/O
C20	V <sub>CCI</sub>	V <sub>CCI</sub>
C21	I/O	I/O
C22	I/O	I/O
C23	I/O	I/O
C24	I/O	I/O
C25	NC*	I/O
C26	NC*	I/O
D1	NC*	I/O
D2	TMS	TMS
D3	I/O	I/O
D4	V <sub>CCI</sub>	V <sub>CCI</sub>
D5	NC*	I/O
D6	TCK, I/O	TCK, I/O
D7	I/O	I/O
D8	I/O	I/O
D9	I/O	I/O
D10	I/O	I/O
D11	I/O	I/O
D12	I/O	QCLKC
D13	I/O	I/O
D14	I/O	I/O
D15	I/O	I/O
D16	I/O	I/O
D17	I/O	I/O
D18	I/O	I/O
D19	I/O	I/O
D20	I/O	I/O
D21	V <sub>CCI</sub>	V <sub>CCI</sub>
D22	GND	GND
D23	I/O	I/O
D24	I/O	I/O
D25	NC*	I/O
D26	NC*	I/O
E1	NC*	I/O

484-Pin FBGA		
Pin Number	A54SX32A Function	A54SX72A Function
E2	NC*	I/O
E3	I/O	I/O
E4	I/O	I/O
E5	GND	GND
E6	TDI, IO	TDI, IO
E7	I/O	I/O
E8	I/O	I/O
E9	I/O	I/O
E10	I/O	I/O
E11	I/O	I/O
E12	I/O	I/O
E13	V <sub>CCA</sub>	V <sub>CCA</sub>
E14	CLKB	CLKB
E15	I/O	I/O
E16	I/O	I/O
E17	I/O	I/O
E18	I/O	I/O
E19	I/O	I/O
E20	I/O	I/O
E21	I/O	I/O
E22	I/O	I/O
E23	I/O	I/O
E24	I/O	I/O
E25	V <sub>CCI</sub>	V <sub>CCI</sub>
E26	GND	GND
F1	V <sub>CCI</sub>	V <sub>CCI</sub>
F2	NC*	I/O
F3	NC*	I/O
F4	I/O	I/O
F5	I/O	I/O
F22	I/O	I/O
F23	I/O	I/O
F24	I/O	I/O
F25	I/O	I/O
F26	NC*	I/O

484-Pin FBGA		
Pin Number	A54SX32A Function	A54SX72A Function
G1	NC*	I/O
G2	NC*	I/O
G3	NC*	I/O
G4	I/O	I/O
G5	I/O	I/O
G22	I/O	I/O
G23	V <sub>CCA</sub>	V <sub>CCA</sub>
G24	I/O	I/O
G25	NC*	I/O
G26	NC*	I/O
H1	NC*	I/O
H2	NC*	I/O
H3	I/O	I/O
H4	I/O	I/O
H5	I/O	I/O
H22	I/O	I/O
H23	I/O	I/O
H24	I/O	I/O
H25	NC*	I/O
H26	NC*	I/O
J1	NC*	I/O
J2	NC*	I/O
J3	I/O	I/O
J4	I/O	I/O
J5	I/O	I/O
J22	I/O	I/O
J23	I/O	I/O
J24	I/O	I/O
J25	V <sub>CCI</sub>	V <sub>CCI</sub>
J26	NC*	I/O
K1	I/O	I/O
K2	V <sub>CCI</sub>	V <sub>CCI</sub>
K3	I/O	I/O
K4	I/O	I/O
K5	V <sub>CCA</sub>	V <sub>CCA</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.

<b>Previous Version</b>	<b>Changes in Current Version (v5.3)</b>	<b>Page</b>
v4.0 (continued)	Table 2-12 was updated.	2-11
	The was updated.	2-14
	The "Sample Path Calculations" were updated.	2-14
	Table 2-13 was updated.	2-17
	Table 2-13 was updated.	2-17
	All timing tables were updated.	2-18 to 2-52
v3.0	The "Actel Secure Programming Technology with FuseLock™ Prevents Reverse Engineering and Design Theft" section was updated.	1-i
	The "Ordering Information" section was updated.	1-ii
	The "Temperature Grade Offering" section was updated.	1-iii
	The Figure 1-1 • SX-A Family Interconnect Elements was updated.	1-1
	The "Clock Resources" section was updated	1-5
	The Table 1-1 • SX-A Clock Resources is new.	1-5
	The "User Security" section is new.	1-7
	The "I/O Modules" section was updated.	1-7
	The Table 1-2 • I/O Features was updated.	1-8
	The Table 1-3 • I/O Characteristics for All I/O Configurations is new.	1-8
	The Table 1-4 • Power-Up Time at which I/Os Become Active is new	1-8
	The Figure 1-12 • Device Selection Wizard is new.	1-9
	The "Boundary-Scan Pin Configurations and Functions" section is new.	1-9
	The Table 1-9 • Device Configuration Options for Probe Capability (TRST Pin Reserved) is new.	1-11
	The "SX-A Probe Circuit Control Pins" section was updated.	1-12
	The "Design Considerations" section was updated.	1-12
	The Figure 1-13 • Probe Setup was updated.	1-12
	The Design Environment was updated.	1-13
	The Figure 1-13 • Design Flow is new.	1-11
	The "Absolute Maximum Ratings*" section was updated.	1-12
	The "Recommended Operating Conditions" section was updated.	1-12
	The "Electrical Specifications" section was updated.	1-12
	The "2.5V LVCMOS2 Electrical Specifications" section was updated.	1-13
	The "SX-A Timing Model" and "Sample Path Calculations" equations were updated.	1-23
The "Pin Description" section was updated.	1-15	
v2.0.1	The "Design Environment" section has been updated.	1-13
	The "I/O Modules" section, and Table 1-2 • I/O Features have been updated.	1-8
	The "SX-A Timing Model" section and the "Timing Characteristics" section have new timing numbers.	1-23